Resistors



Cylindrical Surface Mount MetalGlaze™ Compliant-Terminal Resistors

SMC Series

- · Lead free, RoHS compliant
- Uses standard IRC 2512, 3610 solder pads
- Ideal for automotive and other harsh thermal applications
- Uncompromising Metal Glaze[™] performance gives excellent surge performance
- Capped terminals provide mechanical compliance-relief from board vs. component TCE mismatch



All parts are Pb-free and comply with EU Directive 2011/65/EU (RoHS2)

Electrical Data

IRC Type	Industry Standard Footprint	Power Rating (Watts)	Resistance Range (Ohms)	Tolerance (±%)¹	TCR (±ppm/°C)	Operating Voltage (V)	Maximum Voltage (V)
SMC-1	2512	1.0 @ 70°C	1.0 to 10 Ω	5	200	350	700
			\geq 10 - 1 M Ω	1, 2, 5	100		
SMC-2	3610	2.0 @ 25°C	1.0 to 10 Ω	5	200	500	1000
		1.33 @ 70°C	≥ 10 - 1 MΩ	1, 2, 5	100		

Environmental Data

Characteristics	Maximum Change	Test Method	
Temperature Coefficient (ppm/°C)	As specified	MIL-PRF-55342E Par 4.7.9 (-55°C to +125°C)	
Thermal Shock	$\pm 2.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 1.0\% +0.01\Omega$ (R > 10Ω)	MIL-PRF-55342E Par 4.7.3 (-65°C to +150°C)	
Low Temperature Operation	$\pm 1.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 0.5\% +0.01\Omega$ (R > 10Ω)	MIL-PRF-55342E Par 4.7.4 (-65°C @ working voltage)	
Short Time Overload	$\pm 1.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 0.5\% +0.01\Omega$ (R > 10Ω)	MIL-PRF- <u>55</u> 342E Par 4.7.5 (2.5 x √PxR for 5 seconds)	
High Temperature Exposure	$\pm 1.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 0.5\% +0.01\Omega$ (R > 10Ω)	MIL-PRF-55342E Par 4.7.6 (+150°C for 100 hours)	
Resistance to Bonding	$\pm 1.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 0.5\% +0.01\Omega$ (R > 10Ω)	MIL-PRF-55342E Par 4.7.7 (Reflow soldered to board @ 260°C for 10 seconds)	
Solderability	95% minimum coverage	MIL-STD-202, Method 208 (245°C for 5 seconds)	
Moisture Resistance	$\pm 1.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 0.5\% +0.01\Omega$ (R > 10Ω)	MIL-PRF-55342E Par 4.7.8 (10 cycles, total 240 hours)	
Life Test	$\pm 1.0\% +0.01\Omega$ (R ≤ 10Ω) $\pm 0.5\% +0.01\Omega$ (R > 10Ω)	MIL-PRF-55342E Par 4.7.10 (2000 hours @ 70°C intermittent)	
Terminal Adhesion Strength	±1% +0.01 no mechanical damage	1200 gram push from underside of mounted chip for 60 seconds	
Resistance to Board Bending	±1% +0.01 no mechanical damage	Chip mounted in center of 90mm long board, deflected 5mm so as to exert pull on chip contacts for 10 seconds	
Operating Temperature	-55°C to +150°C		



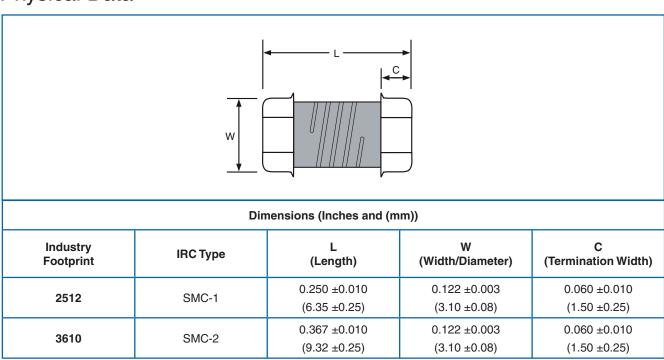


¹ For tolerances below ±1%, please contact factory.

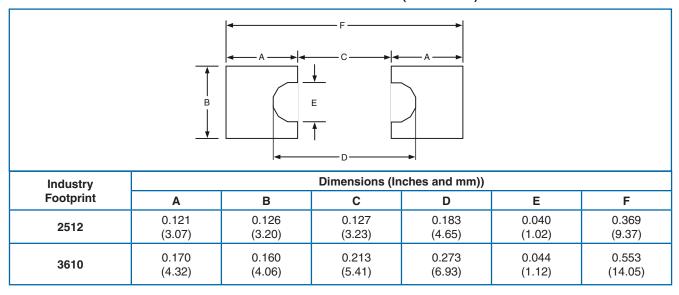


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Physical Data



Recommended Solder Pad Dimensions (Reflow):

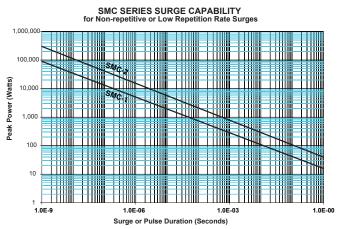


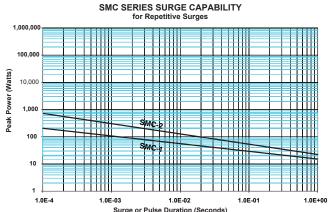
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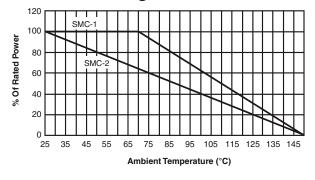


Surge Capabilities





Power Derating Curve



Standard Reel Packaging per EIA-481:

Industry Footprint	Reel Diameter*	Quantity Per Reel	Carrier Tape Width	Component Pitch
SMC-1 2512	7"	750	12mm	4mm
2512	13"	2,500		
SMC-2 3610	13″	2,000	24mm	4mm

^{*}The 13" reel is considered standard and will be supplied unless otherwise specified.

Ordering Data

